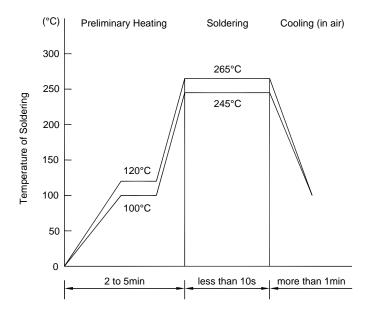
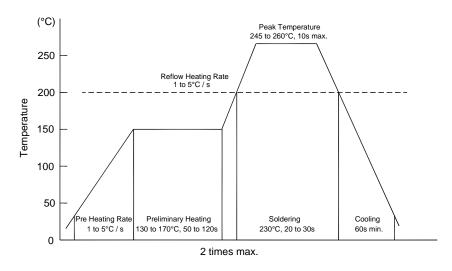
Condition of Soldering for Transistor & Diode

• Recommended condition of flow soldering



Recommended condition of reflow soldering



Recommended peak temperature is over 245 °C. If peak temperature is below 245 °C, you may adjust the following parameters; time length of peak temperature (longer), time length of soldering (longer), thickness of solder paste (thicker)

• Condition of hand soldering

Temperature: 370 °C Time: 3s max. Times: one time

• Remark: Lead free solder paste (96.5Sn/3.0Ag/0.5Cu)









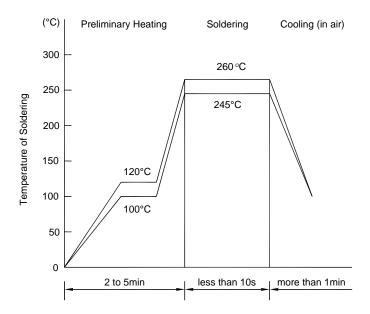




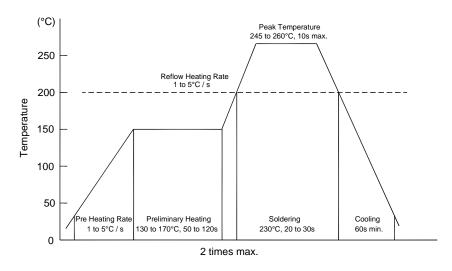
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Soldering Conditions for DO-213AA / AB

• Recommended condition of flow soldering



Recommended condition of reflow soldering



Recommended peak temperature is over 245 °C. If peak temperature is below 245 °C, you may adjust the following parameters; time length of peak temperature (longer), time length of soldering (longer), thickness of solder paste (thicker)

• Condition of hand soldering

Temperature: 290 °C Time: 3 s max. Times: one time

• Remark: Lead free solder paste (96.5Sn/3.0Ag/0.5Cu)



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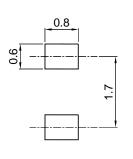




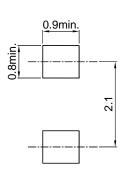


Reference to Copper Plate Area Dimension on PCB

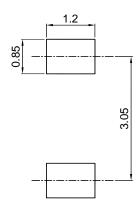
Units: in mm



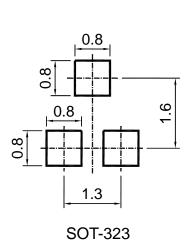


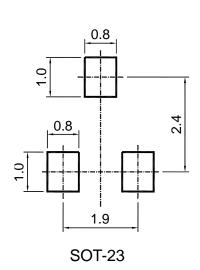


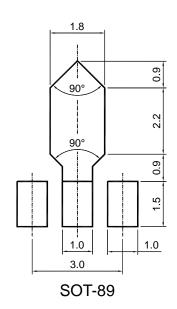
SOD-323

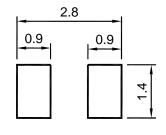


SOD-123

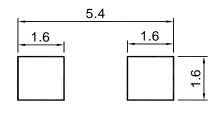




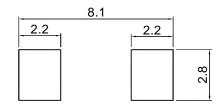




LS-31 (Micro MELF)



LL-34 (Mini MELF) DO-213AA (Mini MELF) LS-34 (Quadro MELF)



LL-41 (MELF) DO-213AB (MELF)



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